



RECOMMENDED PCB LAYOUT

麦拉片

| REV. (版本号) | DESCRIPTION (变更说明) | DATE (日期) | APPD (审核) |
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规格说明: Specifications:

电气特性: Electrical:

- 额定电流: Current Rating
1.0A/contact terminal
- 额定电压: Voltage Rating
30V DC
- 接触阻抗: Contact Resistance
50 milliohms MAX
- 耐电压: Dielectric Withstanding Voltage:
300 V AC AT Sea Level
- 绝缘阻抗: Insulation Resistance:
100MEGA ohms MIN

原材料: Raw material:

- 塑胶: Plastic cement:
High Temperature Thermoplastics,
LCP Black
 - 端子: Contact: Copper Alloy C2680/C5191
 - 外壳: Shell: SPCC/Copper Alloy C2680
- 电镀: Electroplate:
- 端子: Contact: Plated Gold in Mating Area;
Tin On Solder Tails
 - 外壳: Shell:
Nickel Plating

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|---------------------------------------|-----------------------------------|----------------|---------------|------------|--------------|---|
| 深圳市金航标电子有限公司 型号: KH-MINI-SMT-5P-Cu | | WWW.BDS666.COM | | 页码 (SHEET) | 1/1 | 单位 (UNIT): MM |
| 品名 (ITEM NO) | MINI USB 5P/F SMT B型 (0.3T, 0.6柱) | 0755-83044319 | 版本 (REV) | A0 | 日期 (DATE) | 2009.11.16 |
| 料号 (PART NO) | PMBFB-X21D-XXX | | 设计 (DESIGN) | | 审核 (CHECKED) | 未注公差 TOLERANCE (UNSPECIFIED) |
| 图号 (DWG NO) | P-MBF-144 (2B-1) | | 核准 (APPROVED) | | | ±0.30 ±0.20 ±0.10 ±0.05 ±0.02 |